

APPROVAL SHEET

MODEL NO.: _____

CUSTOMER:

CUSTOMER'S APPROVAL:

AUTHORIZED SIGNATURE/STAMP

DATE

MANUFACTURER:

The Fourth Industrial Zone, Luokeng Village, Xiaotie District, Xiaojinkou Town, Huizhou City, Guangdong Province, China

Tel: 0752-7213069/7213070

Fax: 0752-7213065

Submitted by:

Approved by:

Date:

Performance Specification

Model	Marking	V _{max} (V dc)	I _{max} (A)	I _{hold} @25°C (A)	I _{trip} @25°C (A)	P _d Typ. (W)	Maximum Time To Trip		Resistance		认证
							Current (A)	Time (Sec)	R _{i min} (Ω)	R _{1max} (Ω)	UL
SMD0603R001SF	X	60	20	0.01	0.03	0.5	0.2	1.00	15.000	100.000	
SMD0603R002SF	Y	60	20	0.02	0.06	0.5	0.2	1.00	12.000	70.000	
SMD0603R002SF9v	Y	9	20	0.02	0.06	0.5	0.2	1.00	12.000	70.000	√
SMD0603R003SF	Z	30	20	0.03	0.09	0.5	0.2	1.00	6.000	50.000	
SMD0603R003SF9v	Z	9	20	0.03	0.09	0.5	0.2	1.00	6.000	50.000	√
SMD0603R004SF	-	24.0	20	0.04	0.12	0.5	0.20	1.00	4.000	40.000	
SMD0603R005SF	-	15.0	20	0.05	0.15	0.5	0.25	1.00	3.800	30.000	
SMD0603R005SF9v	-	9.0	20	0.05	0.15	0.5	0.25	1.00	3.800	30.000	√
SMD0603R005SF24V	-	24.0	20	0.05	0.15	0.5	0.25	1.00	3.800	30.000	
SMD0603R005SF33V	-	33.0	20	0.05	0.15	0.5	0.25	1.00	3.800	30.000	
SMD0603R010SF	1	15.0	35	0.10	0.30	0.5	0.5	1.00	0.900	6.000	
SMD0603R010SF9v	1	9.0	35	0.10	0.30	0.5	0.5	1.00	0.900	6.000	√
SMD0603R020SF	2	9.0	35	0.20	0.50	0.5	1.0	0.60	0.550	3.500	√
SMD0603R020SF16v	2	16.0	35	0.20	0.50	0.5	1.0	0.60	0.550	3.500	
SMD0603R025SF	2	9.0	35	0.25	0.55	0.5	8.0	0.08	0.500	3.000	√
SMD0603R025SF16v	2	16.0	35	0.25	0.55	0.5	8.0	0.08	0.500	3.000	
SMD0603R035SF	3	6.0	35	0.35	0.75	0.5	8.0	0.10	0.200	1.000	√
SMD0603R040SF	5	6.0	35	0.40	0.80	0.5	8.0	0.10	0.150	0.900	√
SMD0603R050SF	5	6.0	35	0.50	1.00	0.5	8.0	0.10	0.100	0.800	√
SMD0603R050SF12v	5	12.0	35	0.50	1.00	0.5	8.0	0.10	0.100	0.800	
SMD0603R060SF	7	6.0	35	0.60	1.20	0.5	8.0	0.10	0.080	0.600	√
SMD0603R065SF	7	6.0	35	0.65	1.30	0.5	8.0	0.10	0.070	0.550	√
SMD0603R075SF	7	6.0	35	0.75	1.40	0.5	8.0	0.10	0.060	0.450	√
SMD0603R075SF12	7	12.0	35	0.75	1.40	0.5	8.0	0.10	0.060	0.450	
SMD0603R100SF	0	6.0	35	1.00	2.00	0.5	8.0	0.10	0.050	0.300	

V_{max} = Maximum operating voltage device can withstand without damage at rated current (I_{max}).

I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max}).

I_{hold} = Hold Current. Maximum current device will not trip in 25°C still air.

I_{trip} = Trip Current. Minimum current at which the device will always trip in 25°C still air.

P_d = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

R_{i min/max} = Minimum/Maximum device resistance prior to tripping at 25°C.



R_{1max} = Maximum device resistance is measured one hour post reflow.

CAUTION : Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202,Method 215	No change
Vibration	MIL-STD-202,Method 201	No change
Ambient operating conditions : - 40 °C to +85 °C		
Maximum surface temperature of the device in the tripped state is 125 °C		

Agency Approval and Environmental Compliance

Agency	File Number	Regulation	Standard
UL	E486890		2011/65/EU
TUV	pending		EN14582

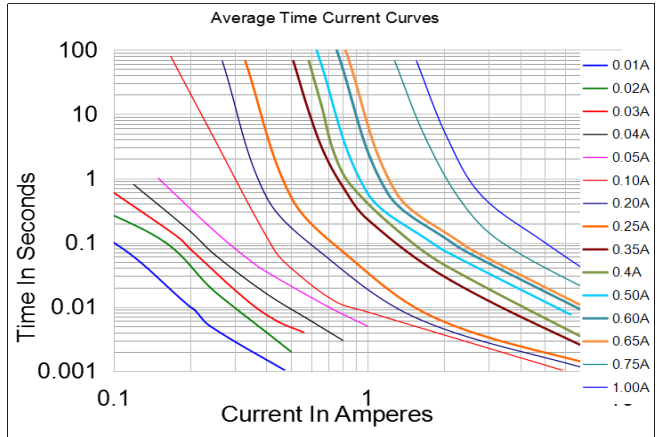
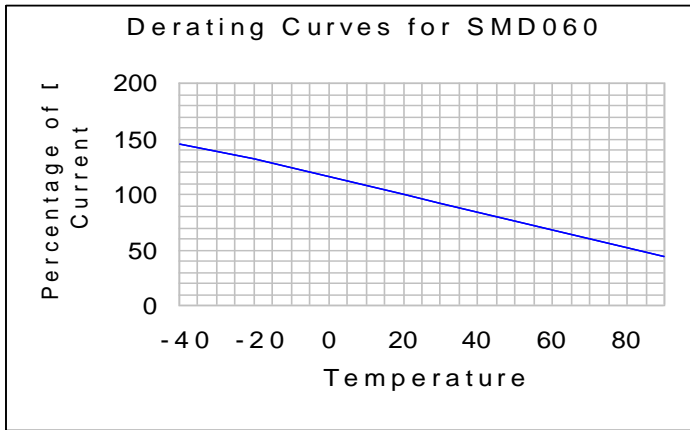
Thermal Derating Chart

Recommended Hold Current(A) at Ambient Temperature(°C)

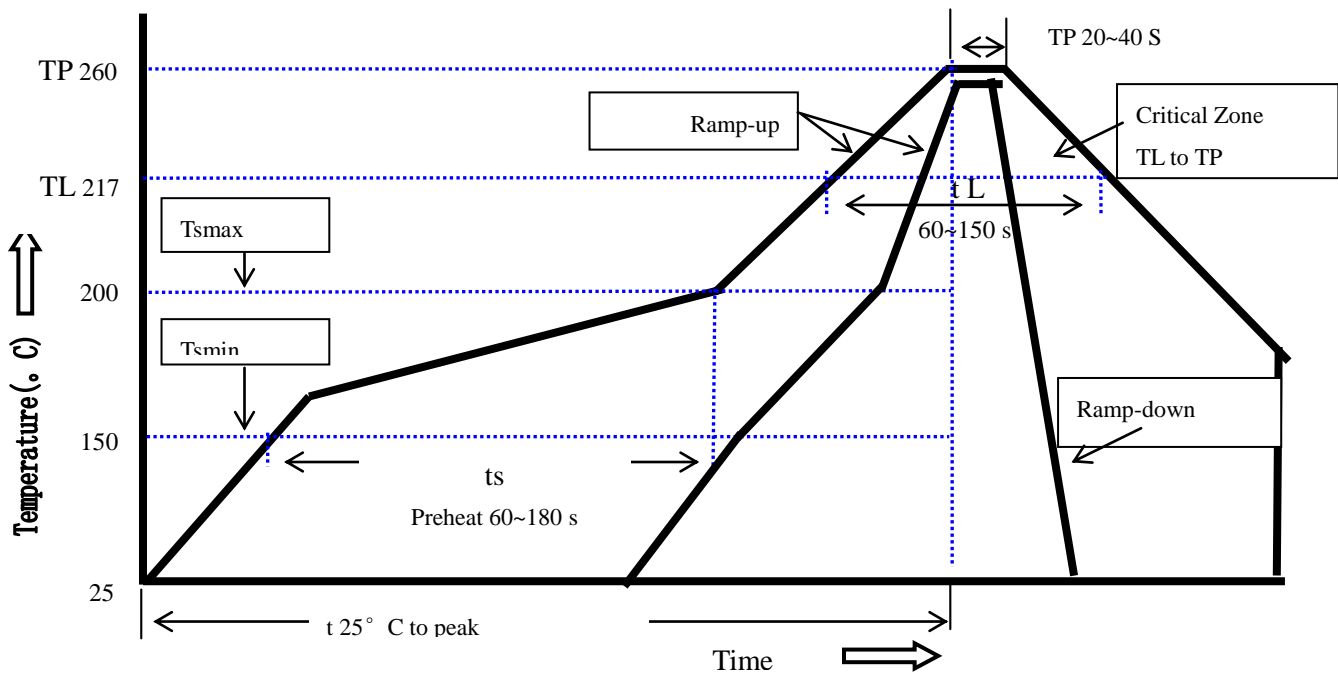
Model	Ambient Operation Temperature								
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
SMD0603R001SF	0.016	0.014	0.012	0.010	0.008	0.007	0.006	0.005	0.0035
SMD0603R002SF	0.031	0.027	0.024	0.020	0.016	0.014	0.012	0.011	0.007
SMD0603R003SF	0.047	0.041	0.036	0.030	0.024	0.021	0.018	0.016	0.0108
SMD0603R004SF	0.052	0.048	0.044	0.040	0.032	0.028	0.024	0.020	0.012
SMD0603R005SF	0.065	0.060	0.055	0.050	0.040	0.035	0.031	0.025	0.015
SMD0603R010SF	0.13	0.12	0.11	0.10	0.08	0.07	0.06	0.05	0.03
SMD0603R020SF	0.27	0.25	0.23	0.20	0.17	0.14	0.12	0.10	0.07
SMD0603R025SF	0.32	0.29	0.27	0.25	0.21	0.18	0.16	0.14	0.10
SMD0603R035SF	0.47	0.41	0.38	0.35	0.29	0.26	0.24	0.20	0.14
SMD0603R040SF	0.54	0.47	0.43	0.40	0.33	0.29	0.27	0.22	0.16
SMD0603R050SF	0.67	0.59	0.54	0.50	0.41	0.37	0.34	0.29	0.20
SMD0603R060SF	0.81	0.70	0.651	0.60	0.49	0.44	0.41	0.34	0.24
SMD0603R065SF	0.87	0.76	0.71	0.65	0.54	0.48	0.44	0.37	0.26
SMD0603R075SF	0.98	0.85	0.81	0.75	0.60	0.54	0.44	0.40	0.31
SMD0603R100SF	1.19	1.13	1.08	1.00	0.80	0.72	0.59	0.54	0.43

Thermal Derating Curve

Average Time-Current Curve



Soldering Parameters



Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate(T_s max to T_p)	3°C/second max.
Preheat	
-Temperature Min(T_s min)	150°C
-Temperature Max(T_s max)	200°C
-Time(T_s min to T_s max)	60~180 seconds
Time maintained above:	
-Temperature(T_L)	217°C
-Time(t_L)	60~150 seconds
Peak Temperature(T_p)	260°C
Ramp-Down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max

RHuiZhou DaRong Electronic Technology CO.,LTD

SMD0603 HF Series Surface Mount PTC Devices

Storage Condition

0°C~30°C,30%-60%RH

Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free

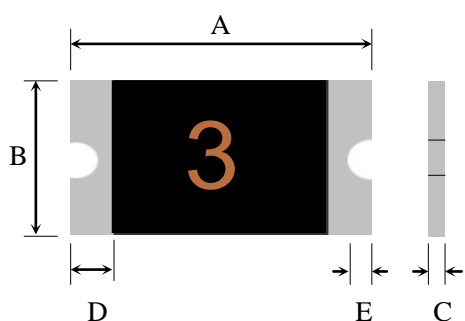
Recommended maximum paste thickness is 0.25mm

Devices can be cleaned using standard industry methods and solvents.

Note 1: All temperature refer to topside of the package, measured on the package body surface.

Note 2: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements

Physical Dimensions(mm.)



型號	A		B		C		D	E
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
SMD0603R001SF	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R002SF9v	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R002SF	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R003SF9v	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R003SF	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R004SF	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R005SF9v	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R005SF	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R005SF24V	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R005SF33V	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R010SF9v	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R010SF	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R020SF	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R020SF16v	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R025SF	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R025SF16v	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10
SMD0603R035SF	1.45	1.85	0.65	1.05	0.35	0.90	0.15	0.10
SMD0603R040SF	1.45	1.85	0.65	1.05	0.40	0.90	0.15	0.10
SMD0603R050SF	1.45	1.85	0.65	1.05	0.55	1.15	0.15	0.10
SMD0603R050SF12v	1.45	1.85	0.65	1.05	0.55	1.15	0.15	0.10
SMD0603R060SF	1.45	1.85	0.65	1.05	0.55	1.15	0.15	0.10
SMD0603R065SF	1.45	1.85	0.65	1.05	0.55	1.15	0.15	0.10

RHuiZhou DaRong Electronic Technology CO.,LTD
SMD0603 HF Series Surface Mount PTC Devices

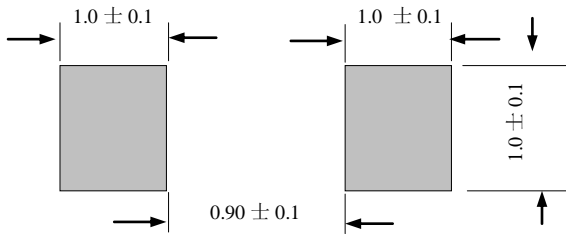
SMD0603R075SF	1.45	1.85	0.65	1.05	0.55	1.15	0.15	0.10
SMD0603R075SF12V	1.45	1.85	0.65	1.05	0.55	1.15	0.15	0.10
SMD0603R100SF	1.45	1.85	0.65	1.05	0.55	1.15	0.15	0.10

Termination Pad Characteristics

Terminal pad materials: Tin-plated Nickel-Copper

Terminal pad solder ability: Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

Recommended Pad Layout (mm.)



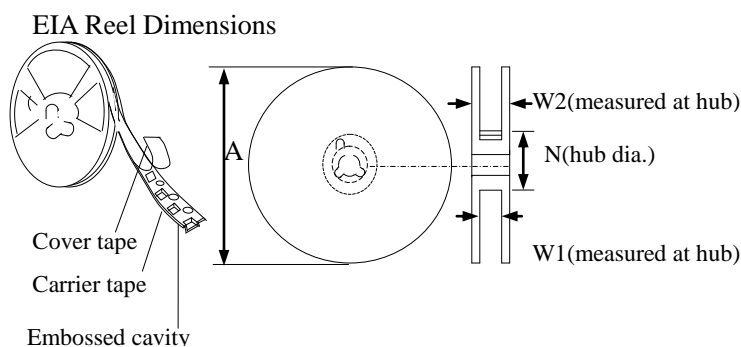
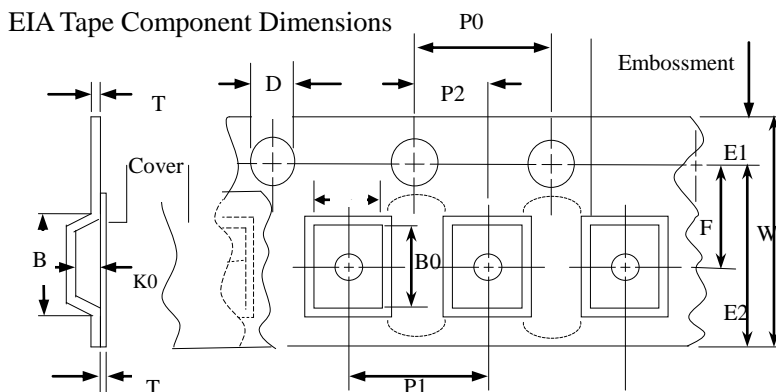
Packaging Quantity

Part Number	Quantity
SMD0603 HF Series	4,000 pcs/reel

Tape & reel packaging per EIA481-1

Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-1
W	8.0 ± 0.2
P ₀	4.0 ± 0.10
P ₁	4.0 ± 0.10
P ₂	2.0 ± 0.05
A ₀	1.05 ± 0.10
B ₀	1.85 ± 0.10
D ₀	1.55 + 0.05
F	3.5 ± 0.05
E ₁	1.75 ± 0.10
E ₂ min.	6.25
T	0.20
T ₁ max.	0.1
K ₀	0.75/0.95 ± 0.1
Leader min.	390
Trailer min.	160
卷軸規格	
A max.	178
N min.	60
W ₁	9.0 ± 0.5
W ₂	12.0 ± 0.05
W	8.0 ± 0.2



Storage And Handling

- Storage conditions: 30°C max, 30%-60% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

Part Number System

SMD 0603 R □□□ S F □□ V

